

MC3x063A 1.5-A Peak Boost/Buck/Inverting Switching Regulators

1 Features

- Wide Input Voltage Range: 3 V to 40 V
- High Output Switch Current: Up to 1.5 A
- Adjustable Output Voltage
- Oscillator Frequency Up to 100 kHz
- Precision Internal Reference: 2%
- Short-Circuit Current Limiting
- Low Standby Current

2 Applications

- Blood Gas Analyzers: Portable
- Cable Solutions
- HMIs (Human Machine Interfaces)
- Telecommunications
- Portable Devices
- Consumer & Computing
- Test & Measurement

3 Description

The MC33063A and MC34063A devices are easy-to-use ICs containing all the primary circuitry needed for building simple DC-DC converters. These devices primarily consist of an internal temperature-compensated reference, a comparator, an oscillator, a PWM controller with active current limiting, a driver, and a high-current output switch. Thus, the devices require minimal external components to build converters in the boost, buck, and inverting topologies.

The MC33063A device is characterized for operation from -40°C to 85°C , while the MC34063A device is characterized for operation from 0°C to 70°C .

Device Information⁽¹⁾

PART NUMBER	PACKAGE (PIN)	BODY SIZE
MC3x063A	SOIC (8)	4.90 mm × 3.91 mm
	SON (8)	4.00 mm × 4.00 mm
	PDIP (8)	9.81 mm × 6.35 mm

(1) For all available packages, see the orderable addendum at the end of the data sheet.

4 Simplified Schematic

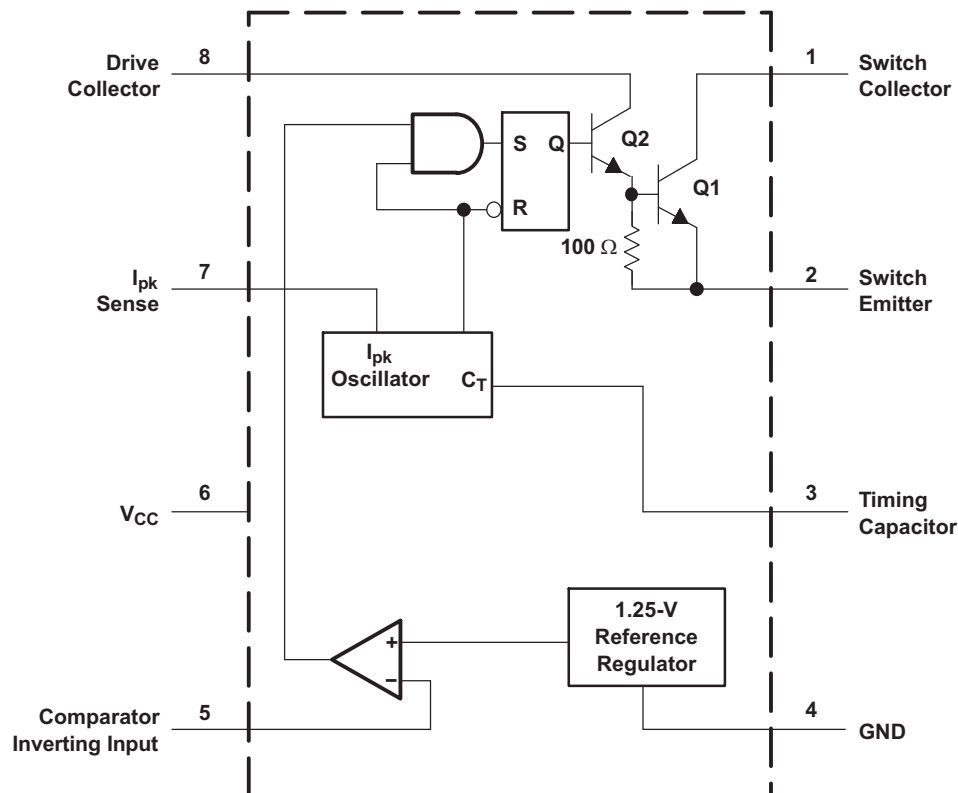


Table of Contents

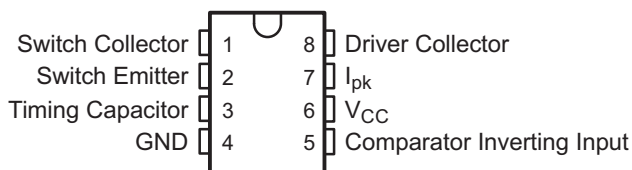
1 Features	1	8.1 Overview	7
2 Applications	1	8.2 Functional Block Diagram	7
3 Description	1	8.3 Feature Description	7
4 Simplified Schematic	1	8.4 Device Functional Modes	7
5 Revision History	2	9 Application and Implementation	8
6 Pin Configuration and Functions	3	9.1 Application Information	8
7 Specifications	4	9.2 Typical Application	9
7.1 Absolute Maximum Ratings	4	10 Power Supply Recommendations	17
7.2 ESD Ratings	4	11 Layout	17
7.3 Recommended Operating Conditions	4	11.1 Layout Guidelines	17
7.4 Thermal Information	4	11.2 Layout Example	17
7.5 Electrical Characteristics—Oscillator	4	12 Device and Documentation Support	18
7.6 Electrical Characteristics—Output Switch	5	12.1 Related Links	18
7.7 Electrical Characteristics—Comparator	5	12.2 Trademarks	18
7.8 Electrical Characteristics—Total Device	5	12.3 Electrostatic Discharge Caution	18
7.9 Typical Characteristics	6	12.4 Glossary	18
8 Detailed Description	7	13 Mechanical, Packaging, and Orderable Information	18

5 Revision History

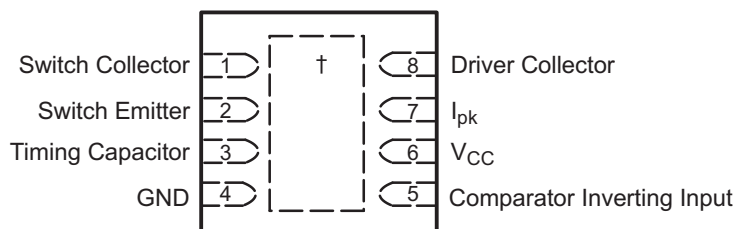
Changes from Revision M (January 2011) to Revision N	Page
Added <i>Applications</i>, <i>Device Information</i> table, <i>Pin Functions</i> table, <i>ESD Ratings</i> table, <i>Thermal Information</i> table, <i>Feature Description</i> section, <i>Device Functional Modes</i>, <i>Application and Implementation</i> section, <i>Power Supply Recommendations</i> section, <i>Layout</i> section, <i>Device and Documentation Support</i> section, and <i>Mechanical, Packaging, and Orderable Information</i> section.	1
Deleted <i>Ordering Information</i> table.	1

6 Pin Configuration and Functions

**D (SOIC) OR P (PDIP) PACKAGE
(TOP VIEW)**



**DRJ (QFN) PACKAGE
(TOP VIEW)**



† The exposed thermal pad is electrically bonded internally to pin 4 (GND) .

Pin Functions

PIN		TYPE	DESCRIPTION
NAME	NO.		
Switch Collector	1	I/O	High-current internal switch collector input.
Switch Emitter	2	I/O	High-current internal switch emitter output.
Timing Capacitor	3	—	Attach a timing capacitor to change the switching frequency.
GND	4	—	Ground
Comparator Inverting Input	5	I	Attach to a resistor divider network to create a feedback loop.
V_{CC}	6	I	Logic supply voltage. Tie to V_{IN} .
I_{PK}	7	I	Current-limit sense input.
Driver Collector	8	I/O	Darlington pair driving transistor collector input.

MC33063A, MC34063A

SLLS636N – DECEMBER 2004 – REVISED JANUARY 2015

7 Specifications

7.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)⁽¹⁾

		MIN	MAX	UNIT
V _{CC}	Supply voltage		40	V
V _{IR}	Comparator inverting input voltage range	–0.3	40	V
V _{C(switch)}	Switch collector voltage		40	V
V _{E(switch)}	Switch emitter voltage		40	V
V _{CE(switch)}	Switch collector to switch emitter voltage		40	V
V _{C(driver)}	Driver collector voltage		40	V
I _{C(driver)}	Driver collector current		100	mA
I _{SW}	Switch current		1.5	A
T _J	Operating virtual junction temperature		150	°C
T _{stg}	Storage temperature range	–65	150	°C

- (1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions* is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

7.2 ESD Ratings

		VALUE	UNIT
V _(ESD)	Electrostatic discharge	2500	V
	Human body model (HBM), per ANSI/ESDA/JEDEC JS-001, all pins ⁽¹⁾ Charged device model (CDM), per JEDEC specification JESD22-C101, all pins ⁽²⁾	1500	

- (1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.
(2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

7.3 Recommended Operating Conditions

		MIN	MAX	UNIT
V _{CC}	Supply voltage	3	40	V
T _A	Operating free-air temperature	MC33063A	–40	85
		MC34063A	0	70

7.4 Thermal Information

THERMAL METRIC ⁽¹⁾		MC33063A			UNIT
		D	DRJ	P	
		8 PINS			
R _{θJA}	Junction-to-ambient thermal resistance	97	41	85	°C/W

- (1) For more information about traditional and new thermal metrics, see the *IC Package Thermal Metrics* application report ([SPRA953](#)).

7.5 Electrical Characteristics—Oscillator

V_{CC} = 5 V, T_A = full operating range (unless otherwise noted) (see block diagram)

PARAMETER	TEST CONDITIONS	T _A	MIN	TYP	MAX	UNIT
f _{osc}	Oscillator frequency	V _{PIN5} = 0 V, C _T = 1 nF	25°C	24	33	42
I _{chg}	Charge current	V _{CC} = 5 V to 40 V	25°C	24	35	42
I _{dischg}	Discharge current	V _{CC} = 5 V to 40 V	25°C	140	220	260
I _{dischg} /I _{chg}	Discharge-to-charge current ratio	V _{PIN7} = V _{CC}	25°C	5.2	6.5	7.5
V _{lpk}	Current-limit sense voltage	I _{dischg} = I _{chg}	25°C	250	300	350

7.6 Electrical Characteristics—Output Switch

$V_{CC} = 5\text{ V}$, $T_A =$ full operating range (unless otherwise noted) (see block diagram)⁽¹⁾

PARAMETER	TEST CONDITIONS	T_A	MIN	TYP	MAX	UNIT
$V_{CE(sat)}$	Saturation voltage – Darlington connection	$I_{SW} = 1\text{ A}$, pins 1 and 8 connected	Full range	1	1.3	V
$V_{CE(sat)}$	Saturation voltage – non-Darlington connection ⁽²⁾	$I_{SW} = 1\text{ A}$, $R_{PIN8} = 82\ \Omega$ to V_{CC} , forced $\beta \sim 20$	Full range	0.45	0.7	V
h_{FE}	DC current gain	$I_{SW} = 1\text{ A}$, $V_{CE} = 5\text{ V}$	25°C	50	75	—
$I_{C(off)}$	Collector off-state current	$V_{CE} = 40\text{ V}$	Full range	0.01	100	μA

(1) Low duty-cycle pulse testing is used to maintain junction temperature as close to ambient temperature as possible.

(2) In the non-Darlington configuration, if the output switch is driven into hard saturation at low switch currents ($\leq 300\text{ mA}$) and high driver currents ($\geq 30\text{ mA}$), it may take up to $2\ \mu\text{s}$ for the switch to come out of saturation. This condition effectively shortens the off time at frequencies $\geq 30\text{ kHz}$, becoming magnified as temperature increases. The following output drive condition is recommended in the non-Darlington configuration:

Forced β of output switch = $I_{C,SW} / (I_{C,driver} - 7\text{ mA}) \geq 10$, where $\sim 7\text{ mA}$ is required by the $100\text{-}\Omega$ resistor in the emitter of the driver to forward bias the V_{be} of the switch.

7.7 Electrical Characteristics—Comparator

$V_{CC} = 5\text{ V}$, $T_A =$ full operating range (unless otherwise noted) (see block diagram)

PARAMETER	TEST CONDITIONS	T_A	MIN	TYP	MAX	UNIT
V_{th}	Threshold voltage	25°C	1.225	1.25	1.275	V
		Full range	1.21		1.29	
ΔV_{th}	Threshold-voltage line regulation	$V_{CC} = 5\text{ V}$ to 40 V	Full range	1.4	5	mV
I_{IB}	Input bias current	$V_{IN} = 0\text{ V}$	Full range	–20	–400	nA

7.8 Electrical Characteristics—Total Device

$V_{CC} = 5\text{ V}$, $T_A =$ full operating range (unless otherwise noted) (see block diagram)

PARAMETER	TEST CONDITIONS	T_A	MIN	MAX	UNIT
I_{CC}	Supply current	$V_{CC} = 5\text{ V}$ to 40 V , $C_T = 1\text{ nF}$, $V_{PIN7} = V_{CC}$, $V_{PIN5} > V_{th}$, $V_{PIN2} = \text{GND}$, All other pins open	Full range	4	mA

MC33063A, MC34063A

SLLS636N – DECEMBER 2004 – REVISED JANUARY 2015

7.9 Typical Characteristics

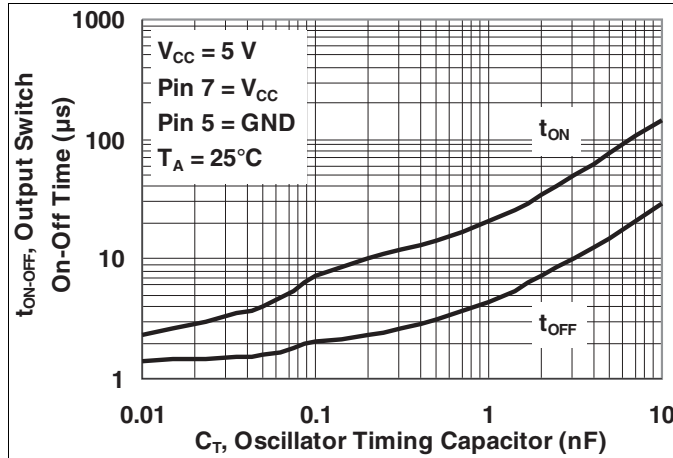


Figure 1. Output Switch On-Off Time vs Oscillator Timing Capacitor

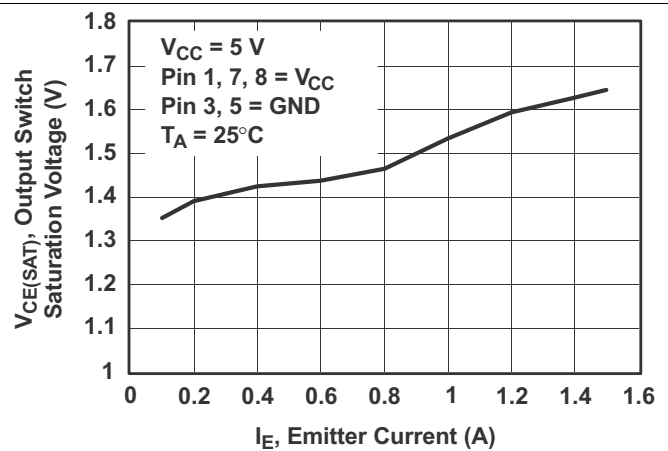


Figure 2. Output Switch Saturation Voltage vs Emitter Current (Emitter-Follower Configuration)

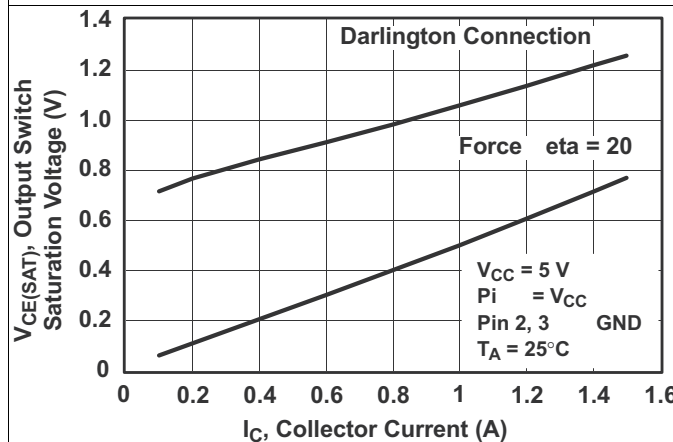


Figure 3. Output Switch Saturation Voltage vs Collector Current (Common-Emitter Configuration)

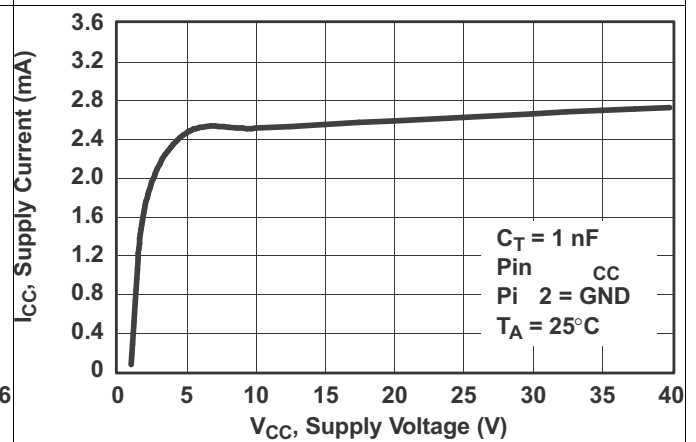


Figure 4. Standby Supply Current vs Supply Voltage

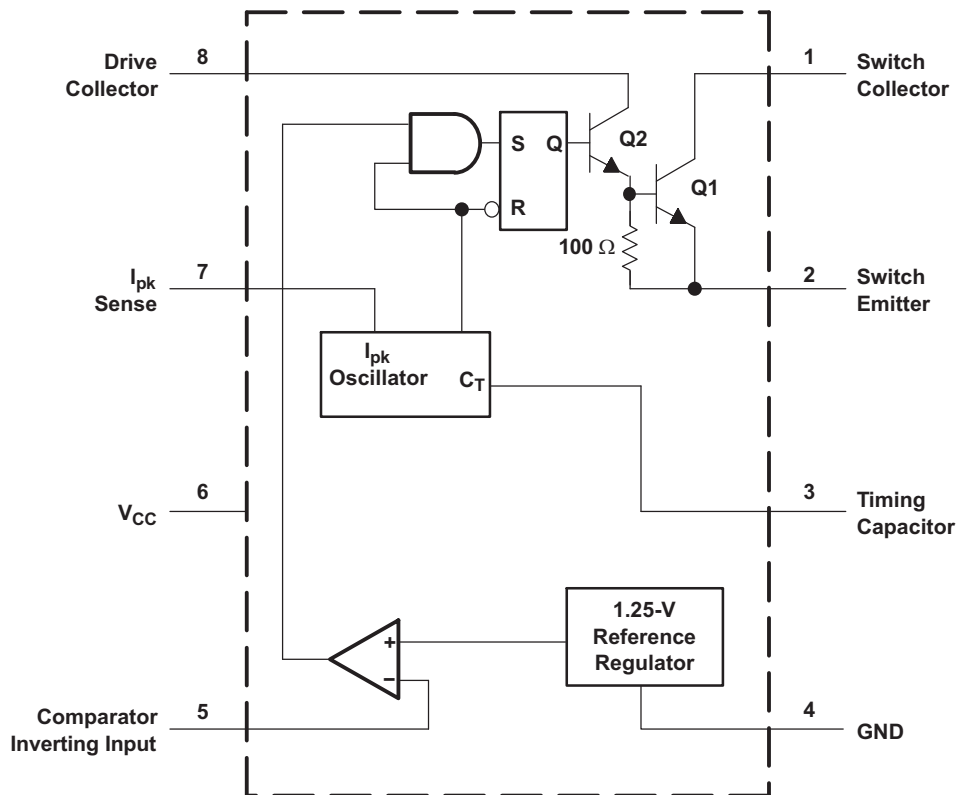
8 Detailed Description

8.1 Overview

The MC33063A and MC34063A devices are easy-to-use ICs containing all the primary circuitry needed for building simple DC-DC converters. These devices primarily consist of an internal temperature-compensated reference, a comparator, an oscillator, a PWM controller with active current limiting, a driver, and a high-current output switch. Thus, the devices require minimal external components to build converters in the boost, buck, and inverting topologies.

The MC33063A device is characterized for operation from -40°C to 85°C , while the MC34063A device is characterized for operation from 0°C to 70°C .

8.2 Functional Block Diagram



8.3 Feature Description

- Wide Input Voltage Range: 3 V to 40 V
- High Output Switch Current: Up to 1.5 A
- Adjustable Output Voltage
- Oscillator Frequency Up to 100 kHz
- Precision Internal Reference: 2%
- Short-Circuit Current Limiting
- Low Standby Current

8.4 Device Functional Modes

8.4.1 Standard operation

Based on the application, the device can be configured in multiple different topologies. See the [Application and Implementation](#) section for how to configure the device in several different operating modes.

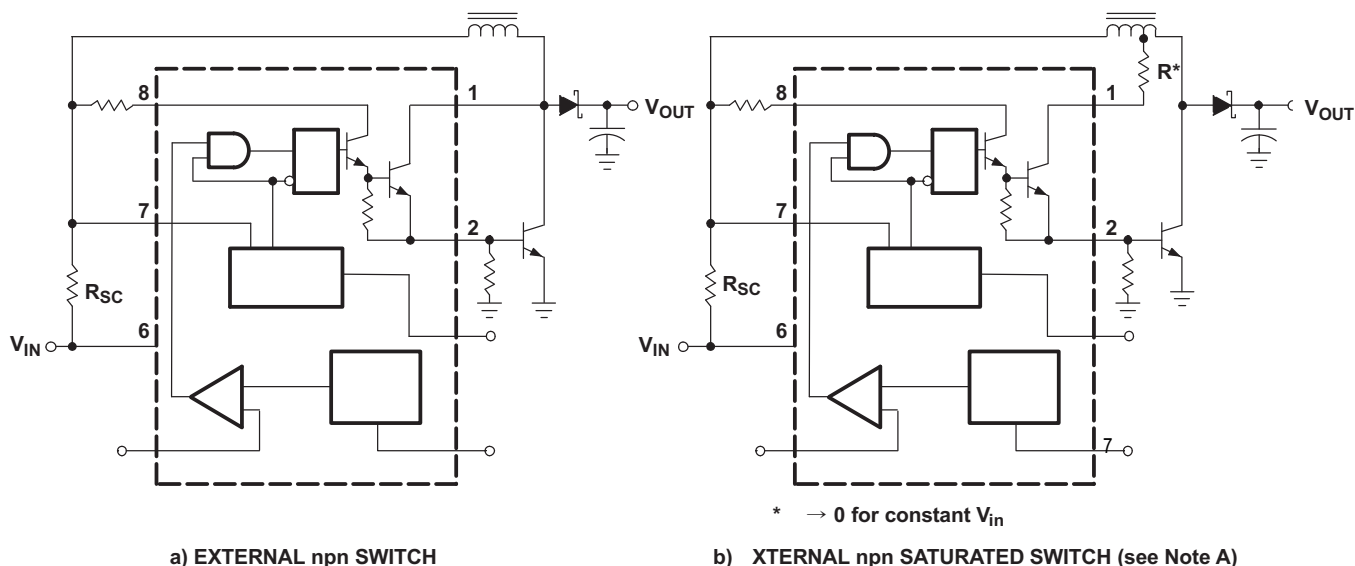
9 Application and Implementation

NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

9.1 Application Information

9.1.1 External Switch Configurations for Higher Peak Current



- A. If the output switch is driven into hard saturation (non-Darlington configuration) at low switch currents (≤ 300 mA) and high driver currents (≥ 30 mA), it may take up to $2 \mu\text{s}$ to come out of saturation. This condition will shorten the off time at frequencies ≥ 30 kHz and is magnified at high temperatures. This condition does not occur with a Darlington configuration because the output switch cannot saturate. If a non-Darlington configuration is used, the output drive configuration in Figure 7b is recommended.

Figure 5. Boost Regulator Connections for I_C Peak Greater Than 1.5 A

Application Information (continued)

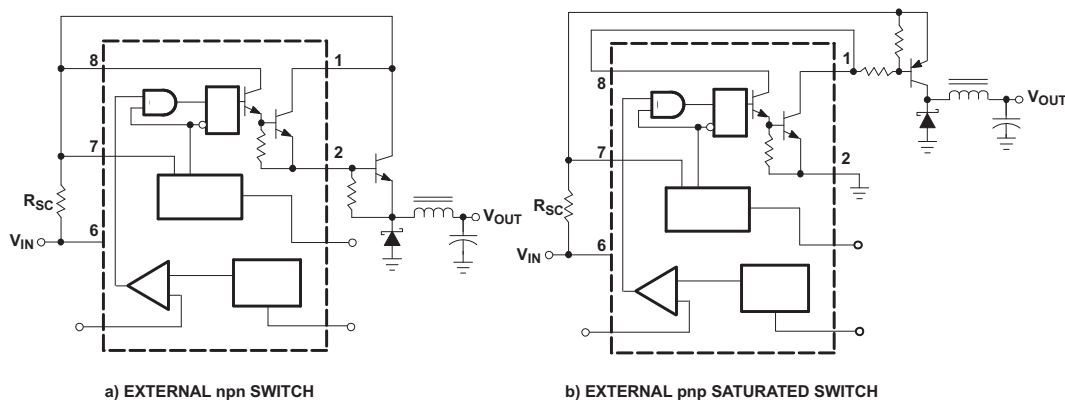


Figure 6. Buck Regulator Connections for I_C Peak Greater Than 1.5 A

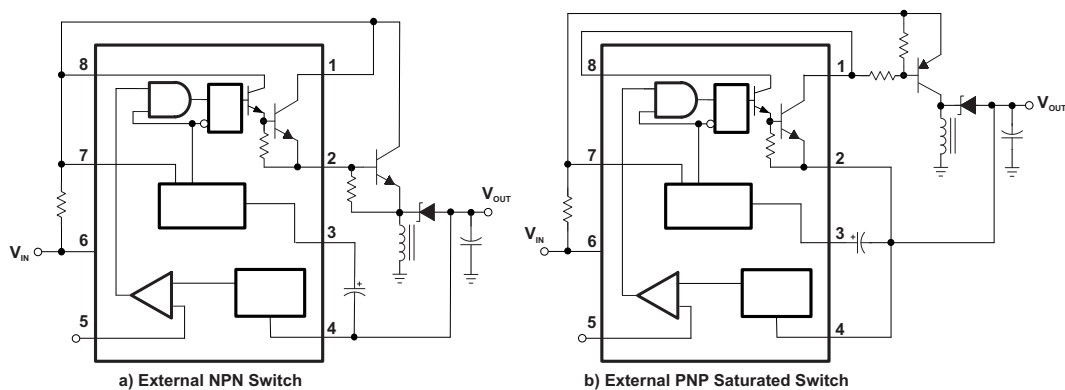
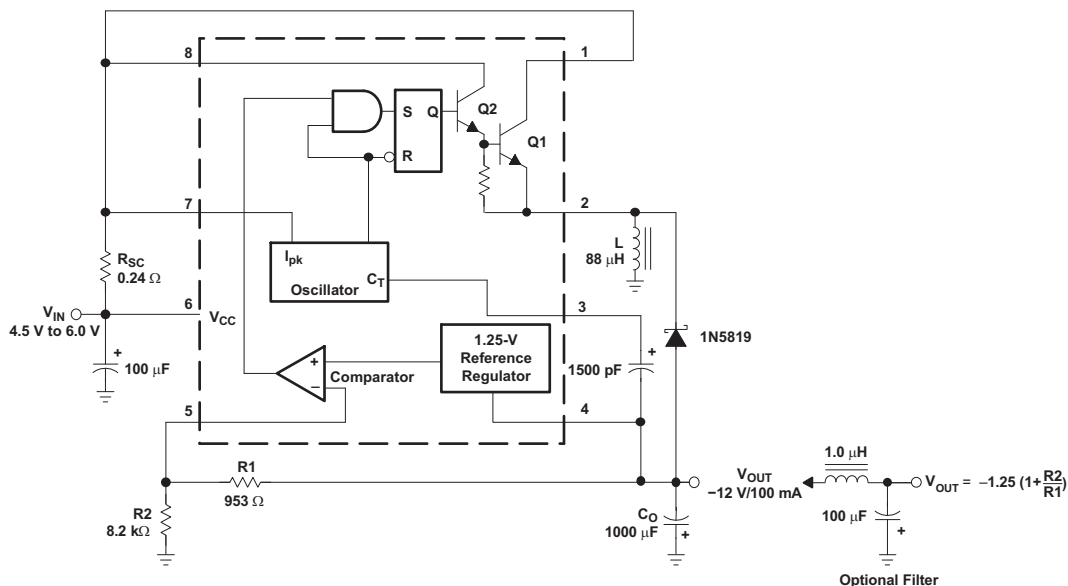


Figure 7. Inverting Regulator Connections for I_C Peak Greater Than 1.5 A

9.2 Typical Application

9.2.1 Voltage-Inverting Converter Application



Typical Application (continued)**Figure 8. Voltage-Inverting Converter**

Typical Application (continued)

9.2.1.1 Design Requirements

The user must determine the following desired parameters:

V_{sat} = Saturation voltage of the output switch

V_F = Forward voltage drop of the chosen output rectifier

The following power-supply parameters are set by the user:

V_{in} = Nominal input voltage

V_{out} = Desired output voltage

I_{out} = Desired output current

f_{min} = Minimum desired output switching frequency at the selected values of V_{in} and I_{out}

V_{ripple} = Desired peak-to-peak output ripple voltage. The ripple voltage directly affects the line and load regulation and, thus, must be considered. In practice, the actual capacitor value should be larger than the calculated value, to account for the capacitor's equivalent series resistance and board layout.

9.2.1.2 Detailed Design Procedure

CALCULATION	VOLTAGE INVERTING
t_{on}/t_{off}	$\frac{ V_{out} + V_F}{V_{in} - V_{sat}}$
$(t_{on} + t_{off})$	$\frac{1}{f}$
t_{off}	$\frac{t_{on} + t_{off}}{\frac{t_{on}}{t_{off}} + 1}$
t_{on}	$(t_{on} + t_{off}) - t_{off}$
C_T	$4 \times 10^{-5} t_{on}$
$I_{pk(switch)}$	$2I_{out(max)} \left(\frac{t_{on}}{t_{off}} + 1 \right)$
R_{SC}	$\frac{0.3}{I_{pk(switch)}}$
$L_{(min)}$	$\left(\frac{(V_{in(min)} - V_{sat})}{I_{pk(switch)}} \right) t_{on(max)}$
C_O	$9 \frac{I_{out} t_{on}}{V_{ripple(pp)}}$
V_{out}	$-1.25 \left(1 + \frac{R_2}{R_1} \right)$ See Figure 8

MC33063A, MC34063A

SLLS636N – DECEMBER 2004 – REVISED JANUARY 2015

9.2.1.3 Application Performance

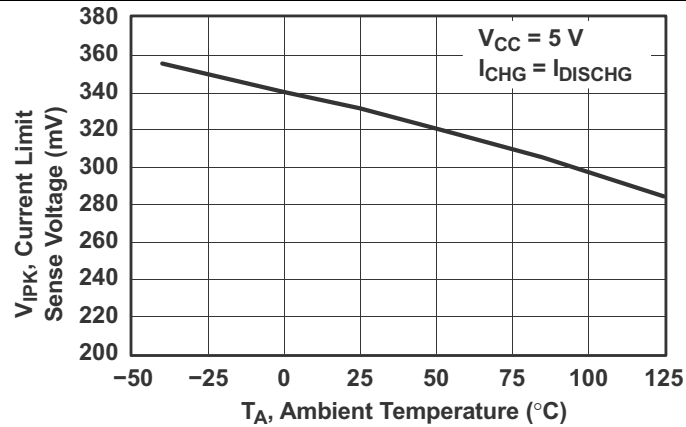


Figure 9. Current-Limit Sense Voltage vs Temperature

TEST	CONDITIONS	RESULTS
Line regulation	$V_{IN} = 4.5 \text{ V to } 6 \text{ V}$, $I_O = 100 \text{ mA}$	$3 \text{ mV} \pm 0.12\%$
Load regulation	$V_{IN} = 5 \text{ V}$, $I_O = 10 \text{ mA to } 100 \text{ mA}$	$0.022 \text{ V} \pm 0.09\%$
Output ripple	$V_{IN} = 5 \text{ V}$, $I_O = 100 \text{ mA}$	500 mV_{PP}
Short-circuit current	$V_{IN} = 5 \text{ V}$, $R_L = 0.1 \Omega$	910 mA
Efficiency	$V_{IN} = 5 \text{ V}$, $I_O = 100 \text{ mA}$	62.2%
Output ripple with optional filter	$V_{IN} = 5 \text{ V}$, $I_O = 100 \text{ mA}$	70 mV_{PP}

9.2.2 Step-Up Converter Application

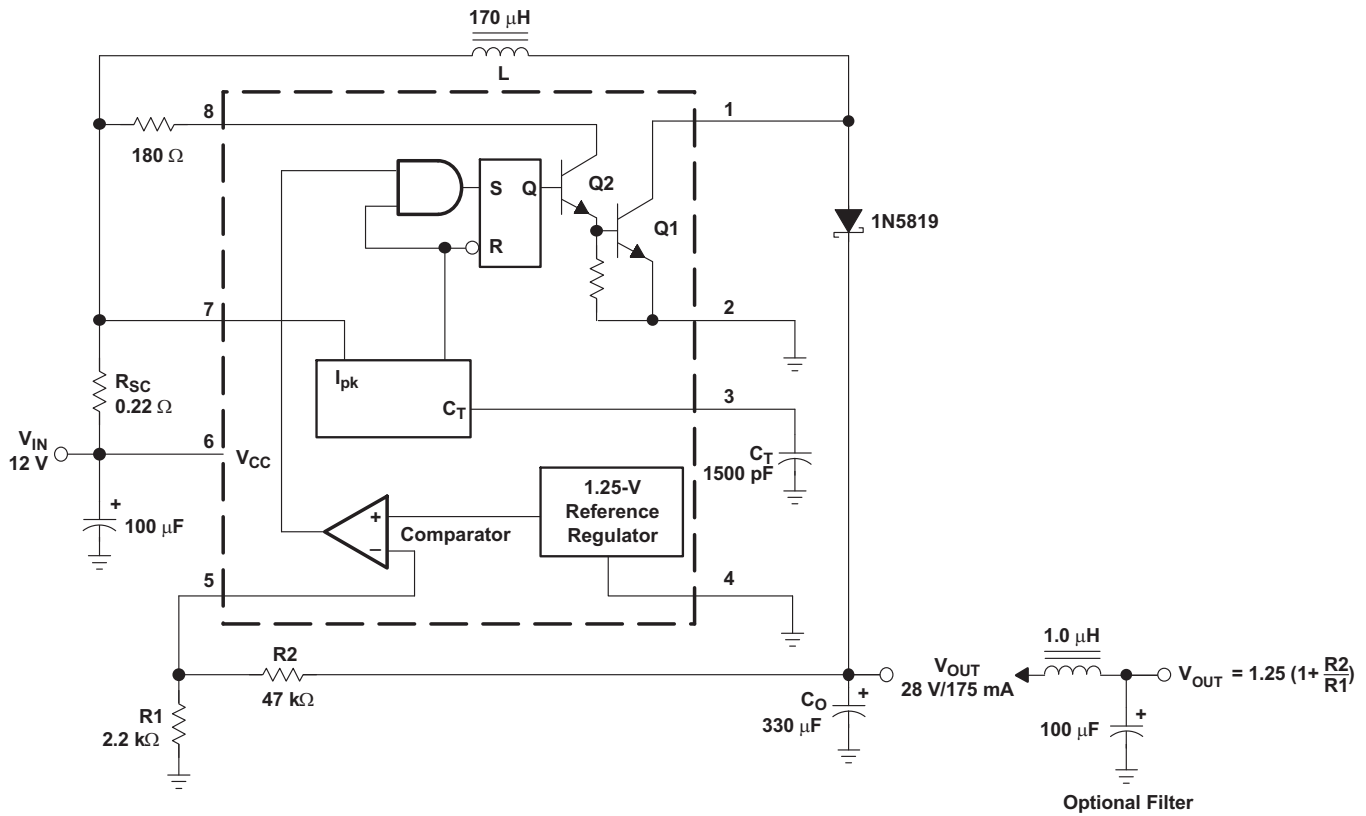


Figure 10. Step-Up Converter

9.2.2.1 Design Requirements

The user must determine the following desired parameters:

V_{sat} = Saturation voltage of the output switch

V_F = Forward voltage drop of the chosen output rectifier

The following power-supply parameters are set by the user:

V_{in} = Nominal input voltage

V_{out} = Desired output voltage

I_{out} = Desired output current

f_{min} = Minimum desired output switching frequency at the selected values of V_{in} and I_{out}

V_{ripple} = Desired peak-to-peak output ripple voltage. The ripple voltage directly affects the line and load regulation and, thus, must be considered. In practice, the actual capacitor value should be larger than the calculated value, to account for the capacitor's equivalent series resistance and board layout.

MC33063A, MC34063A

SLLS636N – DECEMBER 2004 – REVISED JANUARY 2015

9.2.2.2 Detailed Design Procedure

CALCULATION	STEP UP
t_{on}/t_{off}	$\frac{V_{out} + V_{F-Vin(min)}}{V_{in(min)} - V_{sat}}$
$(t_{on} + t_{off})$	$\frac{1}{f}$
t_{off}	$\frac{t_{on} + t_{off}}{\frac{t_{on}}{t_{off}} + 1}$
t_{on}	$(t_{on} + t_{off}) - t_{off}$
C_T	$4 \times 10^{-5} t_{on}$
$I_{pk(switch)}$	$2I_{out(max)} \left(\frac{t_{on}}{t_{off}} + 1 \right)$
R_{SC}	$\frac{0.3}{I_{pk(switch)}}$
$L_{(min)}$	$\left(\frac{(V_{in(min)} - V_{sat})}{I_{pk(switch)}} \right) t_{on(max)}$
C_O	$9 \frac{I_{out} t_{on}}{V_{ripple(pp)}}$
V_{out}	$1.25 \left(1 + \frac{R2}{R1} \right)$ See Figure 10

9.2.2.3 Application Performance

TEST	CONDITIONS	RESULTS
Line regulation	$V_{IN} = 8 \text{ V to } 16 \text{ V}, I_O = 175 \text{ mA}$	$30 \text{ mV} \pm 0.05\%$
Load regulation	$V_{IN} = 12 \text{ V}, I_O = 75 \text{ mA to } 175 \text{ mA}$	$10 \text{ mV} \pm 0.017\%$
Output ripple	$V_{IN} = 12 \text{ V}, I_O = 175 \text{ mA}$	400 mV_{PP}
Efficiency	$V_{IN} = 12 \text{ V}, I_O = 175 \text{ mA}$	87.7%
Output ripple with optional filter	$V_{IN} = 12 \text{ V}, I_O = 175 \text{ mA}$	40 mV_{PP}

9.2.3 Step-Down Converter Application

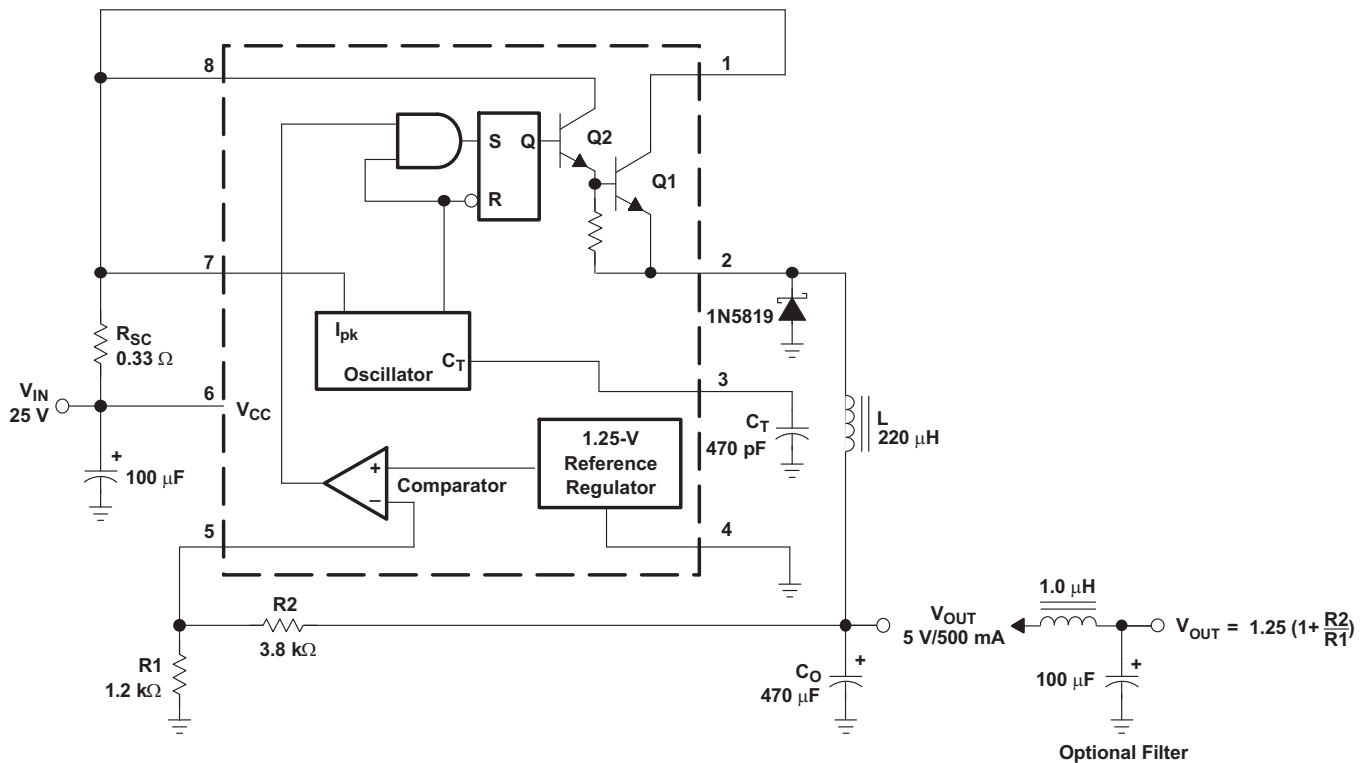


Figure 11. Step-Down Converter

9.2.3.1 Design Requirements

The user must determine the following desired parameters:

V_{sat} = Saturation voltage of the output switch

V_F = Forward voltage drop of the chosen output rectifier

The following power-supply parameters are set by the user:

V_{in} = Nominal input voltage

V_{out} = Desired output voltage

I_{out} = Desired output current

f_{min} = Minimum desired output switching frequency at the selected values of V_{in} and I_{out}

V_{ripple} = Desired peak-to-peak output ripple voltage. The ripple voltage directly affects the line and load regulation and, thus, must be considered. In practice, the actual capacitor value should be larger than the calculated value, to account for the capacitor's equivalent series resistance and board layout.

MC33063A, MC34063A

SLLS636N – DECEMBER 2004 – REVISED JANUARY 2015

9.2.3.2 Detailed Design Procedure

CALCULATION	STEP DOWN
t_{on}/t_{off}	$\frac{V_{out} + V_F}{V_{in(min)} - V_{sat} - V_{out}}$
$(t_{on} + t_{off})$	$\frac{1}{f}$
t_{off}	$\frac{t_{on} + t_{off}}{\frac{t_{on}}{t_{off}} + 1}$
t_{on}	$(t_{on} + t_{off}) - t_{off}$
C_T	$4 \times 10^{-5} t_{on}$
$I_{pk(switch)}$	$2I_{out(max)}$
R_{SC}	$\frac{0.3}{I_{pk(switch)}}$
$L_{(min)}$	$\left(\frac{(V_{in(min)} - V_{sat} - V_{out})}{I_{pk(switch)}} \right) t_{on(max)}$
C_O	$\frac{I_{pk(switch)}(t_{on} + t_{off})}{8V_{ripple(pp)}}$
V_{out}	$1.25 \left(1 + \frac{R_2}{R_1} \right)$ See Figure 11

9.2.3.3 Application Performance

TEST	CONDITIONS	RESULTS
Line regulation	$V_{IN} = 15 \text{ V to } 25 \text{ V}, I_O = 500 \text{ mA}$	$12 \text{ mV} \pm 0.12\%$
Load regulation	$V_{IN} = 25 \text{ V}, I_O = 50 \text{ mA to } 500 \text{ mA}$	$3 \text{ mV} \pm 0.03\%$
Output ripple	$V_{IN} = 25 \text{ V}, I_O = 500 \text{ mA}$	120 mV_{PP}
Short-circuit current	$V_{IN} = 25 \text{ V}, R_L = 0.1 \Omega$	1.1 A
Efficiency	$V_{IN} = 25 \text{ V}, I_O = 500 \text{ mA}$	83.7%
Output ripple with optional filter	$V_{IN} = 25 \text{ V}, I_O = 500 \text{ mA}$	40 mV_{PP}

10 Power Supply Recommendations

This device accepts 3 V to 40 V on the input. It is recommended to have a 1000- μ F decoupling capacitor on the input.

11 Layout

11.1 Layout Guidelines

Keep feedback loop layout trace lengths to a minimum to avoid unnecessary IR drop. In addition, the loop for the decoupling capacitor at the input should be as small as possible. The trace from V_{IN} to pin 1 of the device should be thicker to handle the higher current.

11.2 Layout Example

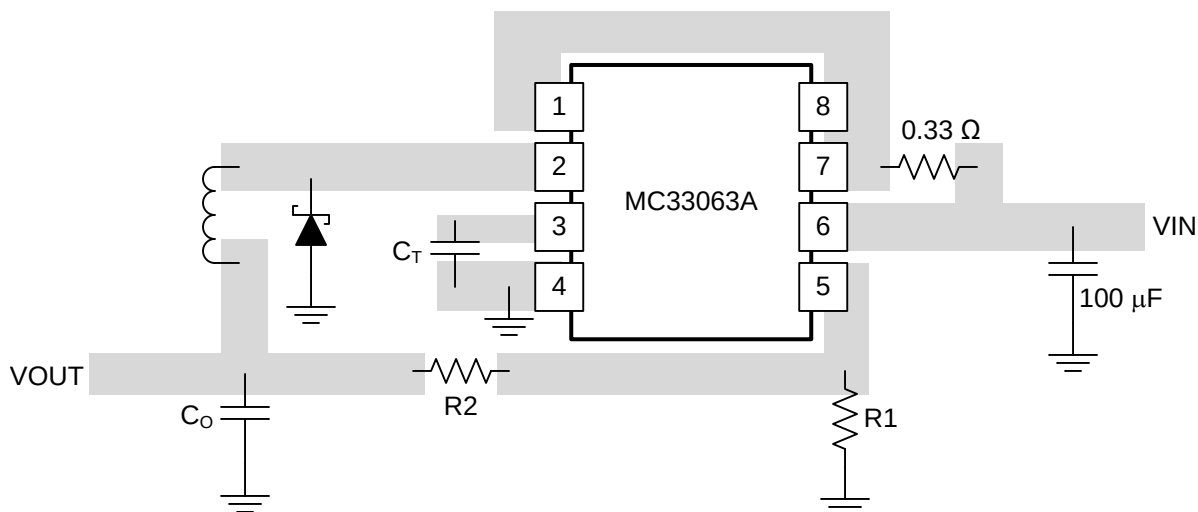
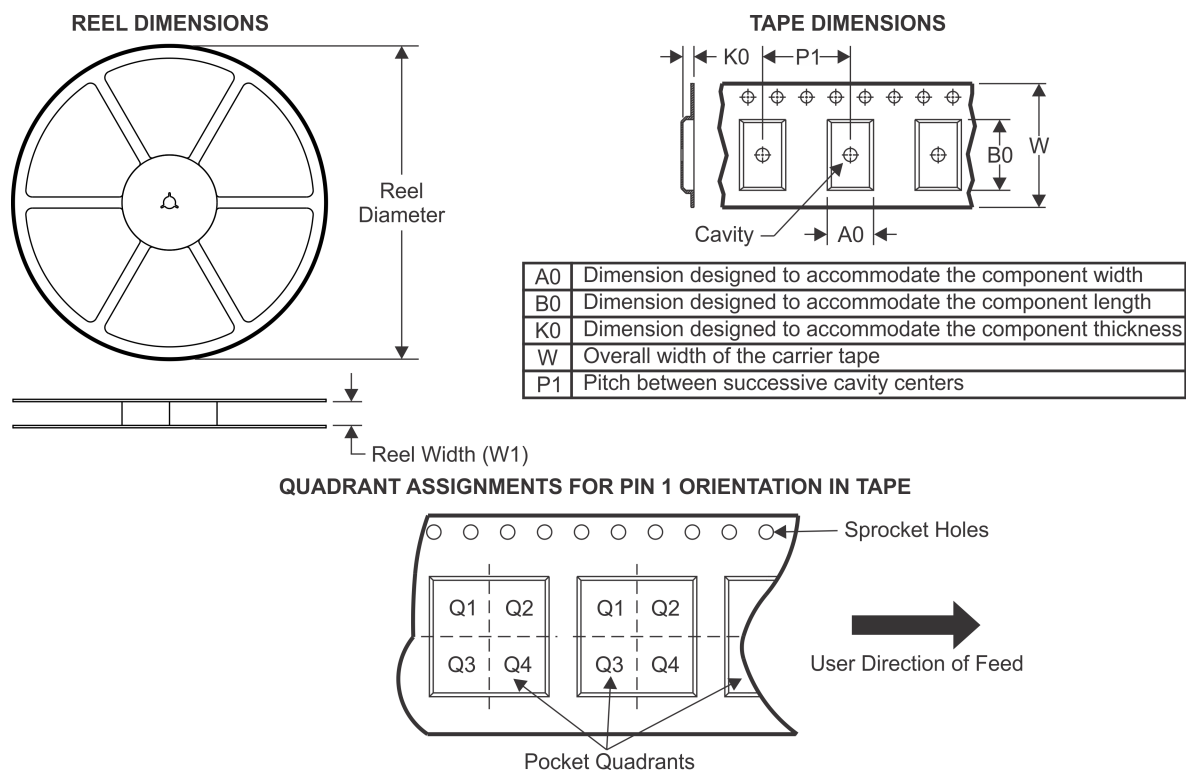


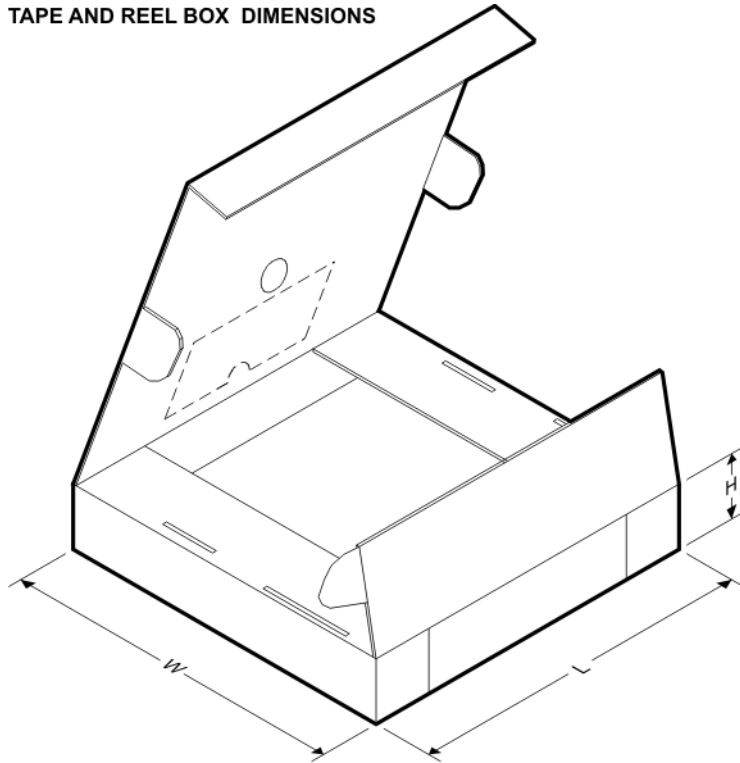
Figure 12. Layout Example for a Step-Down Converter

TAPE AND REEL INFORMATION


*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
MC33063ADR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
MC33063ADR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
MC33063ADRJR	SON	DRJ	8	1000	330.0	12.4	4.25	4.25	1.15	8.0	12.0	Q2
MC34063ADR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
MC34063ADRJR	SON	DRJ	8	1000	180.0	12.4	4.25	4.25	1.15	8.0	12.0	Q2

TAPE AND REEL BOX DIMENSIONS

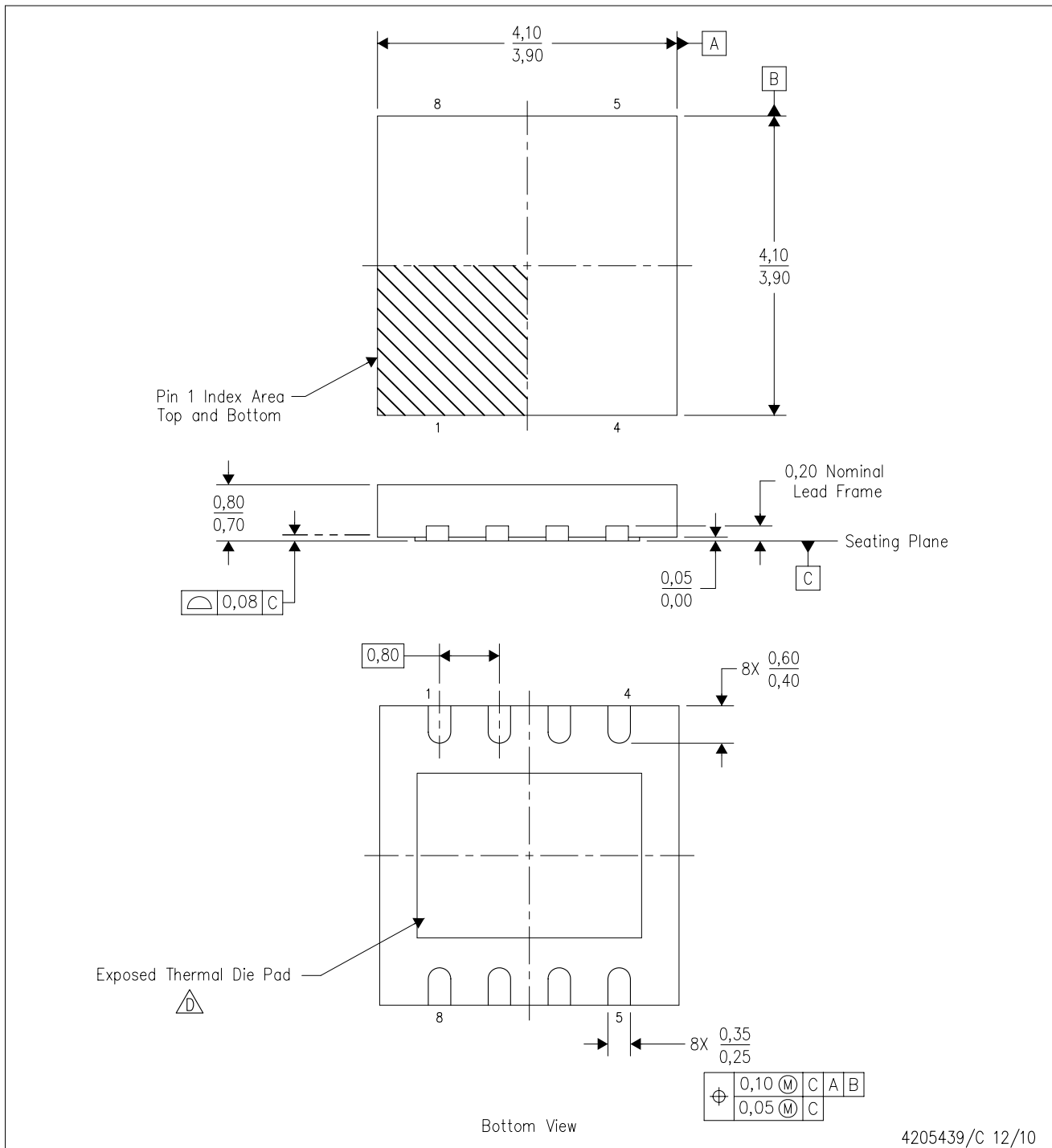


*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
MC33063ADR	SOIC	D	8	2500	367.0	367.0	35.0
MC33063ADR	SOIC	D	8	2500	340.5	338.1	20.6
MC33063ADRJR	SON	DRJ	8	1000	367.0	367.0	35.0
MC34063ADR	SOIC	D	8	2500	340.5	338.1	20.6
MC34063ADRJR	SON	DRJ	8	1000	210.0	185.0	35.0

DRJ (S-PWSON-N8)

PLASTIC SMALL OUTLINE NO-LEAD



4205439/C 12/10

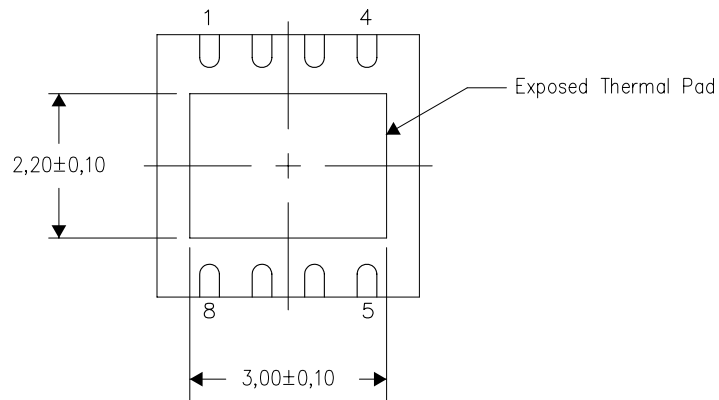
- NOTES:
- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
 - B. This drawing is subject to change without notice.
 - C. SON (Small Outline No-Lead) package configuration.
 - The package thermal pad must be soldered to the board for thermal and mechanical performance. See the Product Data Sheet for details regarding the exposed thermal pad dimensions.
 - E. Package complies to JEDEC MO-229 variation WGGB.

THERMAL INFORMATION

This package incorporates an exposed thermal pad that is designed to be attached directly to an external heatsink. The thermal pad must be soldered directly to the printed circuit board (PCB). After soldering, the PCB can be used as a heatsink. In addition, through the use of thermal vias, the thermal pad can be attached directly to the appropriate copper plane shown in the electrical schematic for the device, or alternatively, can be attached to a special heatsink structure designed into the PCB. This design optimizes the heat transfer from the integrated circuit (IC).

For information on the Quad Flatpack No-Lead (QFN) package and its advantages, refer to Application Report, QFN/SON PCB Attachment, Texas Instruments Literature No. SLUA271. This document is available at www.ti.com.

The exposed thermal pad dimensions for this package are shown in the following illustration.

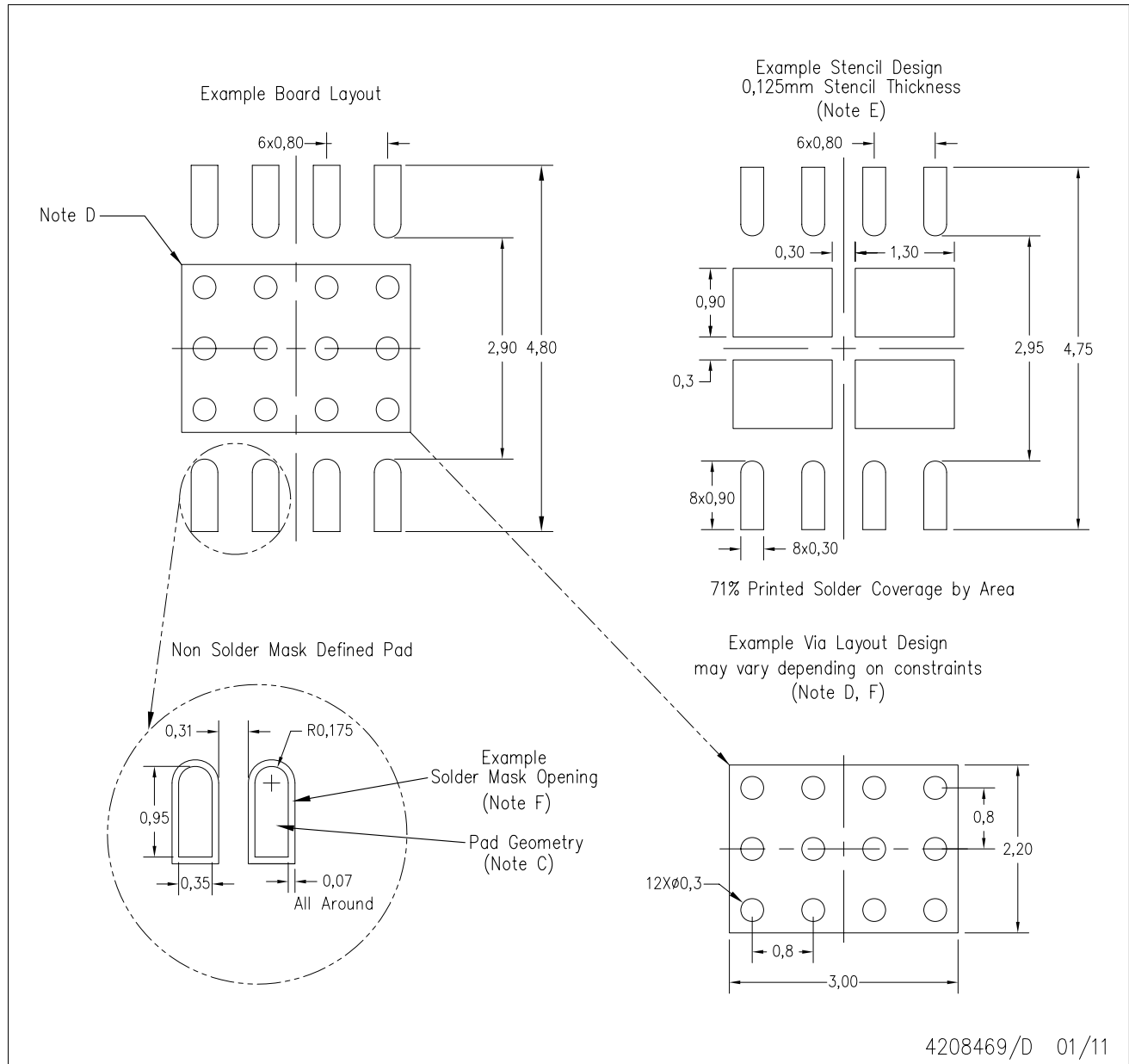


Bottom View

Exposed Thermal Pad Dimensions

DRJ (S-PWSON-N8)

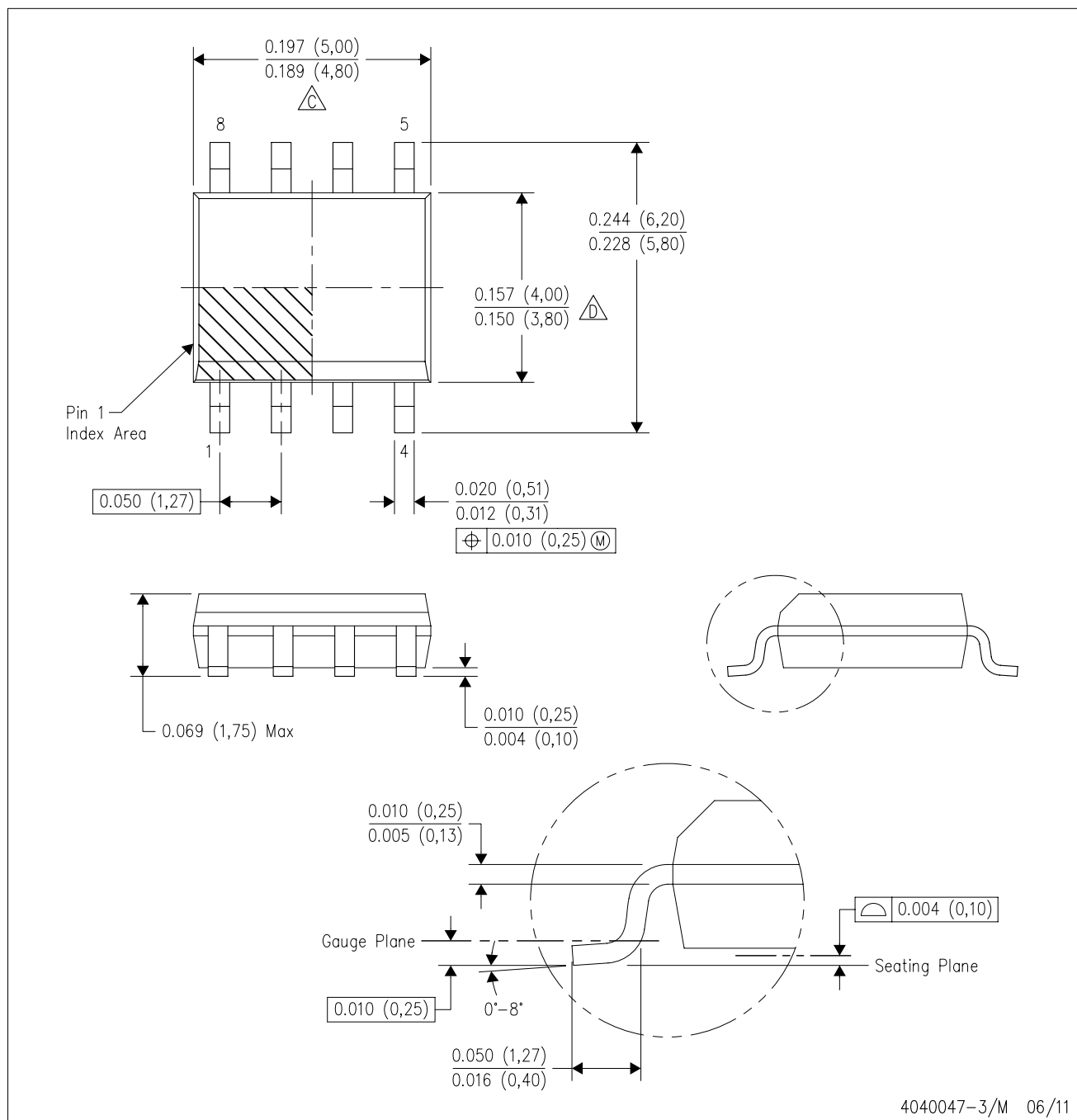
SMALL PACKAGE OUTLINE NO-LEAD



- NOTES:
- All linear dimensions are in millimeters.
 - This drawing is subject to change without notice.
 - Publication IPC-7351 is recommended for alternate designs.
 - This package is designed to be soldered to a thermal pad on the board. Refer to Application Note, Quad Flat-Pack Packages, Texas Instruments Literature No. SLUA271, and also the Product Data Sheets for specific thermal information, via requirements, and recommended board layout. These documents are available at www.ti.com <<http://www.ti.com>>.
 - Laser cutting apertures with electropolish and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC 7525 for stencil design considerations.
 - Customers should contact their board fabrication site for solder mask tolerances and vias tenting recommendations for vias placed in the thermal pad.

D (R-PDSO-G8)

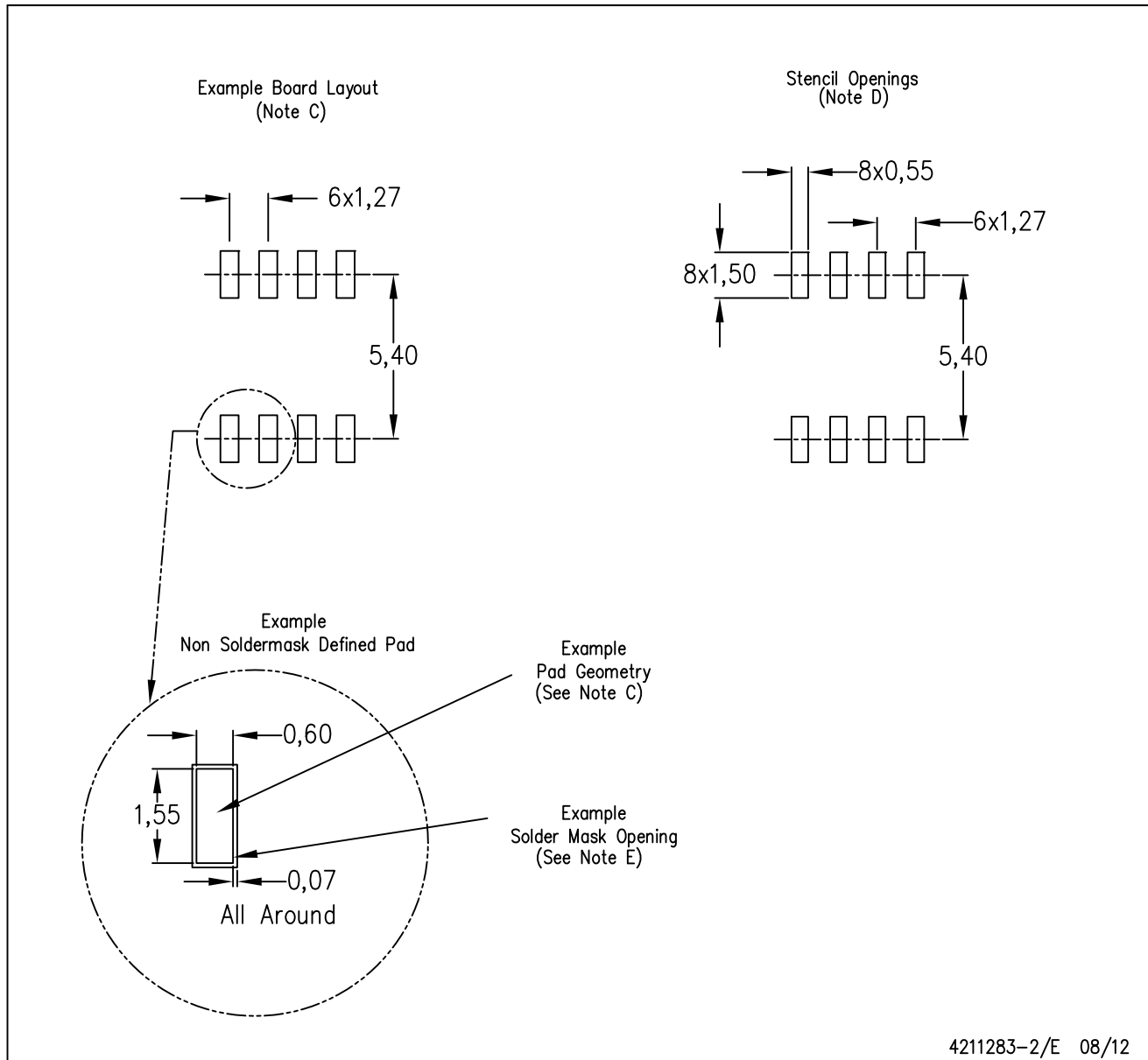
PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - $\triangle C$ Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
 - $\triangle D$ Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
 - E. Reference JEDEC MS-012 variation AA.

D (R-PDSO-G8)

PLASTIC SMALL OUTLINE

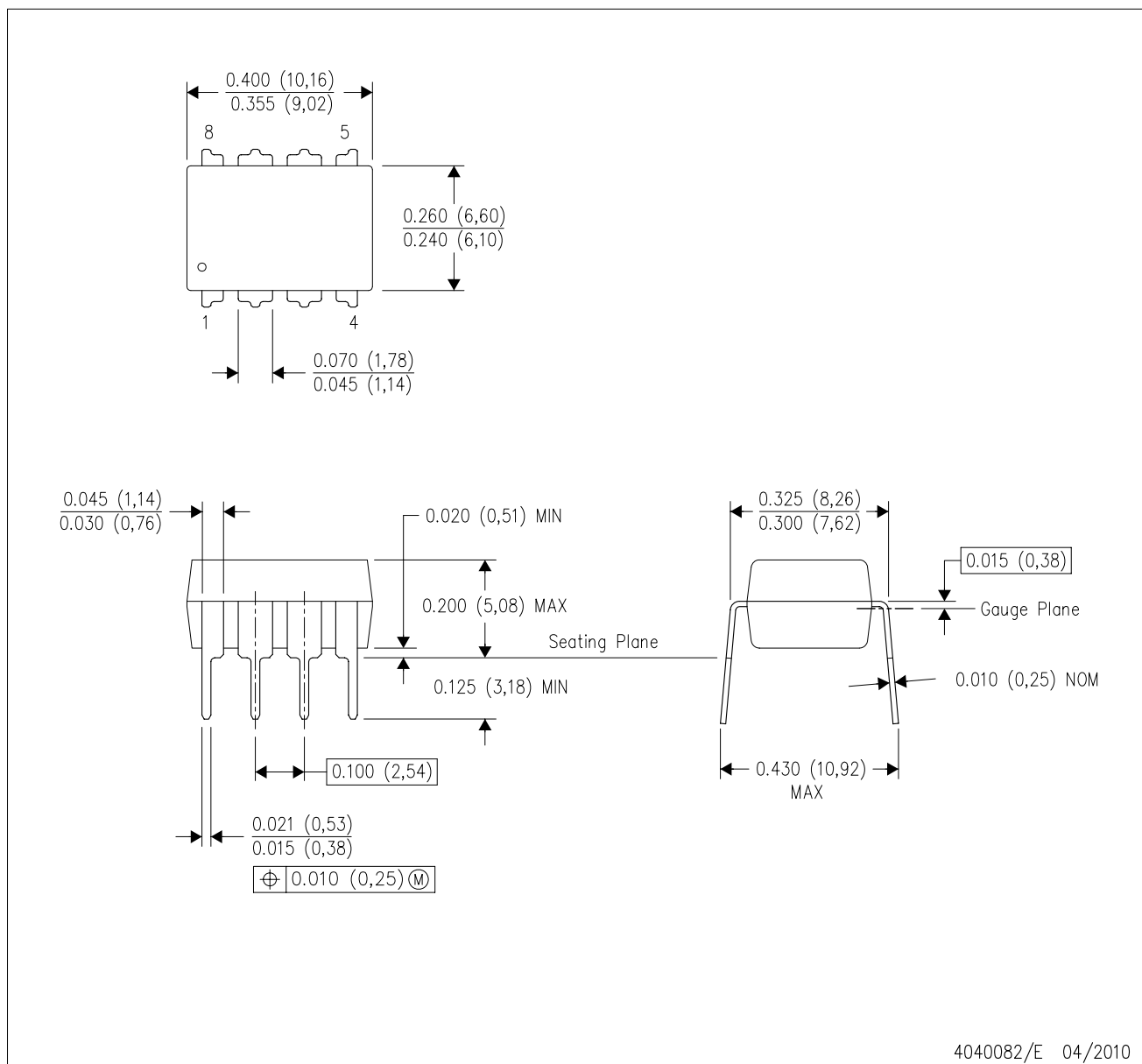


4211283-2/E 08/12

- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Publication IPC-7351 is recommended for alternate designs.
 - D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
 - E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

P (R-PDIP-T8)

PLASTIC DUAL-IN-LINE PACKAGE



- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. Falls within JEDEC MS-001 variation BA.